

## EAST Search History

L9	2018	(void gap hole) same 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:13
L10	2018	(void gap hole) same 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:30
L11	316499	(dielectric polyimide polyimide polymer photoimag\$4 glass sin sin son ((si silicon) adj2 (nitride dioxide oxynitride))) with (spacer spac\$4 bump ball sphere stub post)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:28
L12	71450	(stack\$4 mount\$4 layered multi\$4) same 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:29
L13	21182	(wire conductor conductive wiring) same 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:29
L14	4584	(void gap hole) same 13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:32
L15	3046	14 same (device assembly moldule structure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:35
L16	2388	(periphery border edge outer) and 15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:36

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"5892417".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 12:26
L2	4	"3811186".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 12:26
L3	2	"5684677".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 12:28
L4	263399	(dielectric polyimide polyimide polymer photoimag\$4 glass sin sin son ((si silicon) adj2 (nitride dioxide oxynitride))) with (spacer spac\$4 stub post)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:28
L5	62682	(stack\$4 mount\$4 layered multi\$4) same 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:29
L6	23301	(die dice chip ic semiconductor (integrated adj circuit) microelectronic electronic element microprocessor (semi adj conductor) ) same 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 12:38
L7	6368	(wire conductor conductoive wiring) same 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 12:38
L8	8902	(wire conductor conductive wiring) same 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/13 13:29